

In the Specification

Please amend the title as follows:

~~Radiation Patterning Tools, And Methods Of Printing Structures~~ Methods Of Forming
Aligned Structures With Radiation-Sensitive Material.

At page 1, before the "Technical Field" section, please insert,

RELATED PATENT DATA

This patent resulted from a divisional application of U.S. Patent Application Serial
No. 10/226,005, which was filed August 21, 2002.